Tyrone Camarero Specifications



Camerero: RSI100A3R-212

Key Feature

- 3rd Gen Intel® Xeon Single Processor
- 8 x DDR4, Max 3200Mhz,RDIMM: up to 64GB/DIMM, RDIMM/LRDIMM-3DS: up to 256GB/DIMM
- 4 x16 PCle4.0, 3 x8 PCle4.0 + 2,1 x M.2 PCle Gen3.0 x4 , 1 x M.2 PCle Gen3.0 x1
- 1 Mini-SAS HD + 8 SATA 7-pin (Intel® C621A : RAID 0/1/5/10)
- 1 x RJ45 GbE connector for BMC dedicate management port
- 2 x Intel® i210 1GbE (RJ45)
- 4 x USB3.2 Gen1 type-A connector at rear I/O, 1 x USB3 pin header supports two
- 12 x front loaded 2.5"/3.5" bays(SAS/SATA)
- Support CRPS PSU(FSP) 800W/1200W/1600W





Processor/Cache		
Processor	3rd Gen Intel® Xeon	Single Processor

System M	lemory

Memory	8 x DDR4, Max 3200Mhz,RDIMM: up t
Capacity	64GB/DIMM, RDIMM/LRDIMM-3DS:
	tion to DECCD /DIMANA

up to 256GB/DIMM

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PCI-Express	4 x16 PCle4.0, 3 x8 F	PCle4.0 + 2,1 x M.2 PCle

Gen3.0 x4, 1 x M.2 PCle Gen3.0 x1

Integrated Onboard:

SAS/SATA	1 Mini-SAS HD + 8 SATA 7-pin (Intel®
Storage	C621A: RAID 0/1/5/10)

Front Panel

4 x USB3.2 Gen1 type-A connector at rear I/O, 1 x USB3 pin header supports **Ports** two USB3.1 Gen, 1 x DB-15 VGA

connector.

1x COM connector, 1x external

UID/switch button

Drive bays

HDD Bays 12 x 3.5 /2.5(SAS/SATA) Hot

Swappable Bays

Power Supply

Power Supply Support CRPS PSU(FSP)

800W/1200W/1600W

Form Factor

Form Factor 2U Rackmount

Dimensions

Dimensions 660 x 436 x 87 mm

Email: Info@tyronesystems.com For more/current product information, Visit www.tyronesystems.com

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